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Rohm Semiconductor
TT8J2TR

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ROHM SEMICONDUCTOR

Data Sheet

4V Drive Pch MOSFET

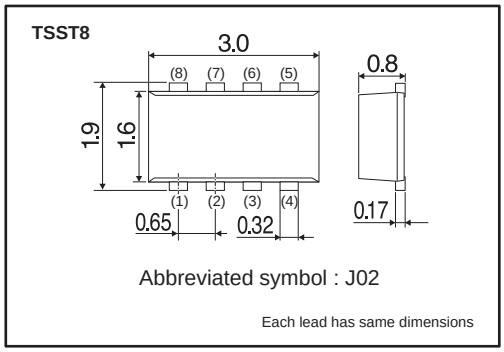
TT8J2

●Structure
Silicon P-channel MOSFET

●Features
1) Low On-resistance.
2) High Power Package.
3) Low voltage drive. (4V)

●Applications
Switching

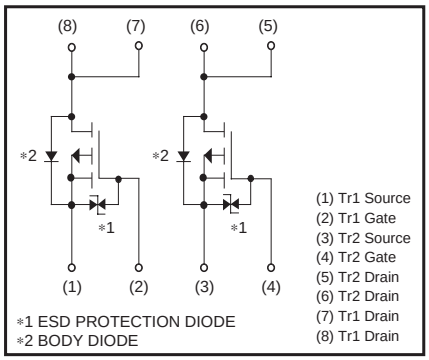
●Dimensions (Unit : mm)



●Packaging specifications

Type	Package	Taping
	Code	TR
	Basic ordering unit (pieces)	3000
TT8J2		◯

●Inner circuit



●Absolute maximum ratings (Ta=25°C)
<It is the same ratings for the Tr1 and Tr2.>

Parameter		Symbol	Limits	Unit
Drain-source voltage		V_{DSS}	−30	V
Gate-source voltage		V_{GSS}	±20	V
Drain current	Continuous	I_D	±2.5	A
	Pulsed	I_{DP} ∗1	±10	A
Source current (Body diode)	Continuous	I_S	−0.8	A
	Pulsed	I_{SP} ∗1	−10	A
Total power dissipation		P_D ∗2	1.25	W / TOTAL
			1.0	W / ELEMENT
Channel temperature		Tch	150	°C
Range of Storage temperature		Tstg	−55 to +150	°C

∗1 Pw≤10μs, Duty cycle≤1%
∗2 When mounted on a ceramic board

●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a) ∗	100	°C / W / TOTAL
		125	°C / W / ELEMENT

∗ Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

<It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	–	–	±10	μA	V_{GS}=±20V, V_{DS}=0V
Drain-source breakdown voltage	$V_{(BR)\ DSS}$	–30	–	–	V	I_D= –1mA, V_{GS}=0V
Zero gate voltage drain current	I_{DSS}	–	–	–1	μA	V_{DS}= –30V, V_{GS}=0V
Gate threshold voltage	$V_{GS\ (th)}$	–1.0	–	–2.5	V	V_{DS}= –10V, I_D= –1mA
Static drain-source on-state resistance	$R_{DS\ (on)}$*	–	60	84	mΩ	I_D= –2.5A, V_{GS}= –10V
		–	95	130	mΩ	I_D= –1.2A, V_{GS}= –4.5V
		–	115	160	mΩ	I_D= –1.2A, V_{GS}= –4V
Forward transfer admittance	$\|Y_{fs}\|$ *	1.8	–	–	S	V_{DS}= –10V, I_D= –2.5A
Input capacitance	C_{iss}	–	460	–	pF	V_{DS}= –10V
Output capacitance	C_{oss}	–	65	–	pF	V_{GS}=0V
Reverse transfer capacitance	C_{rss}	–	40	–	pF	f=1MHz
Turn-on delay time	$t_{d\ (on)}$ *	–	7	–	ns	V_{DD}≒ –15V
Rise time	t_r *	–	20	–	ns	V_{GS}= –10V
Turn-off delay time	$t_{d\ (off)}$ *	–	35	–	ns	I_D= –1.2A
Fall time	t_f *	–	14	–	ns	R_L≒12.5Ω
						R_G=10Ω
Total gate charge	Q_g *	–	4.8	–	nC	V_{DD}≒ –15V
Gate-source charge	Q_{gs} *	–	1.8	–	nC	V_{GS}= –5V
Gate-drain charge	Q_{gd} *	–	1.2	–	nC	I_D= –2.5A
						R_L≒6Ω / R_G=10Ω

*Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{SD}*	–	–	–1.2	V	I_S= –2.5A, V_{GS}=0V

* Pulsed

TT8J2 Data Sheet

●Electrical characteristic curves

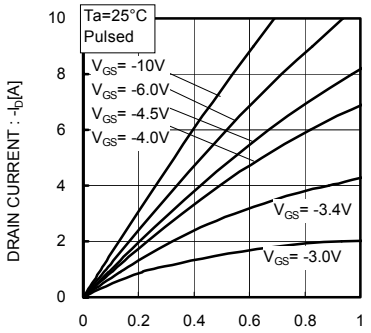


Fig.1 Typical Output Characteristics(Ⅰ)

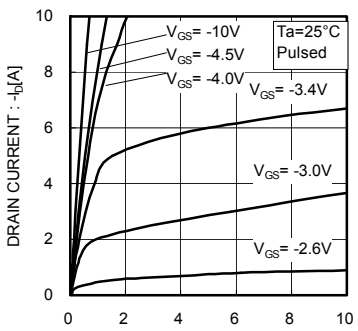


Fig.2 Typical Output Characteristics(Ⅱ)

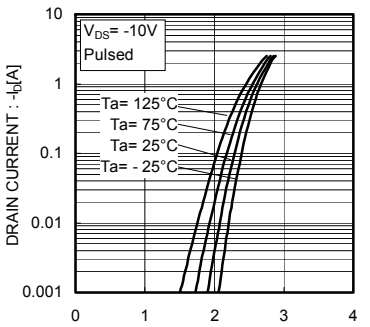


Fig.3 Typical Transfer Characteristics

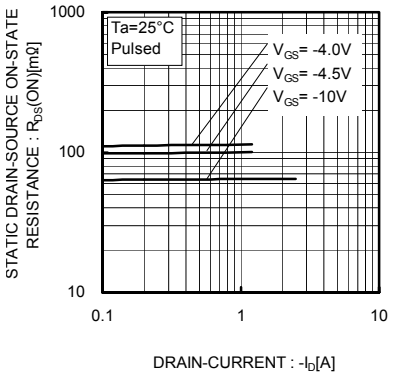


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(Ⅰ)

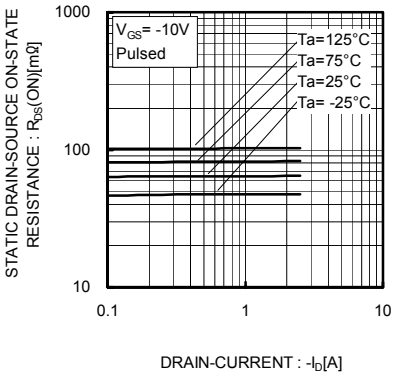


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(Ⅱ)

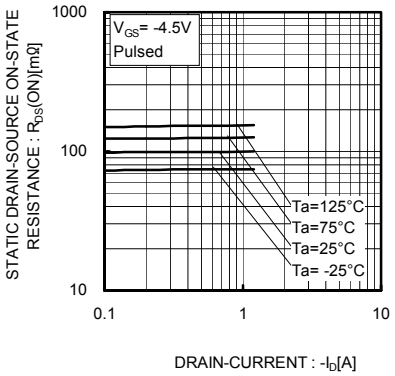


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(Ⅲ)

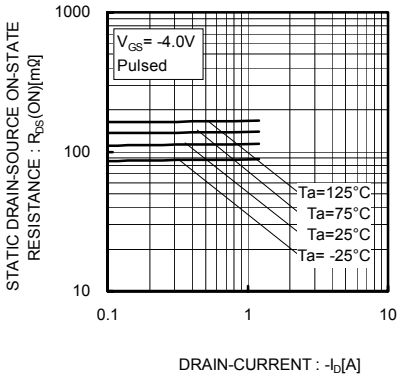


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(Ⅳ)

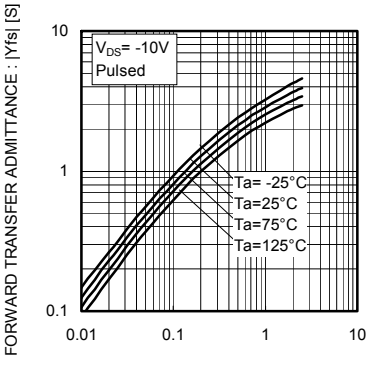


Fig.8 Forward Transfer Admittance vs. Drain Current

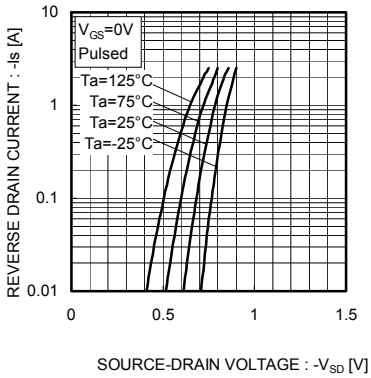


Fig.9 Reverse Drain Current vs. Sourse-Drain Voltage

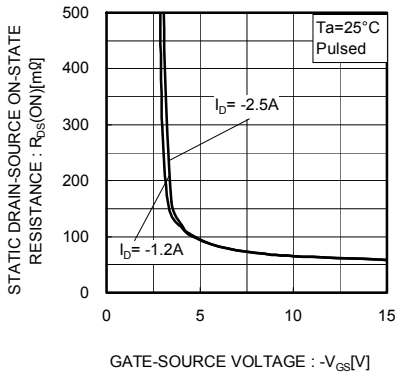


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

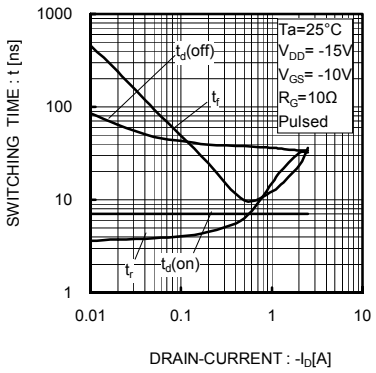


Fig.11 Switching Characteristics

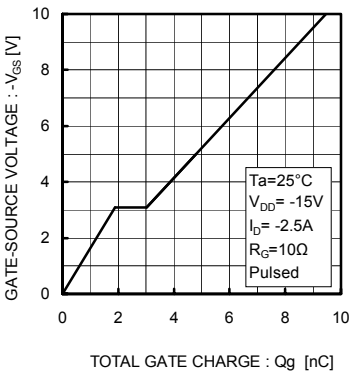


Fig.12 Dynamic Input Characteristics

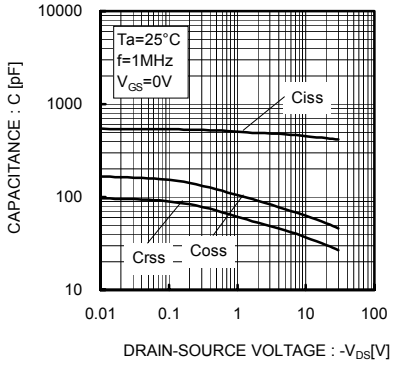


Fig.13 Typical Capacitance vs. Drain-Source Voltage

●Measurement circuits

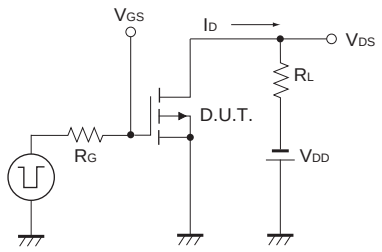


Fig.1-1 Switching Time Measurement Circuit

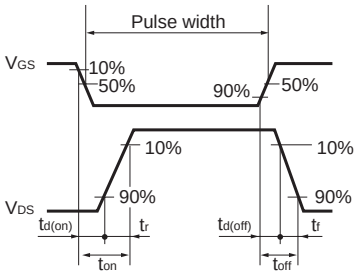


Fig.1-2 Switching Waveforms

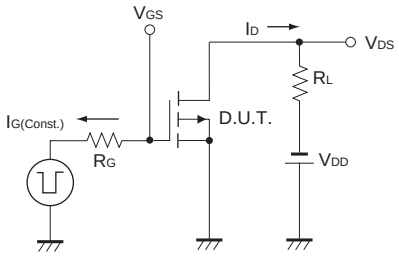


Fig.2-1 Gate Charge Measurement Circuit

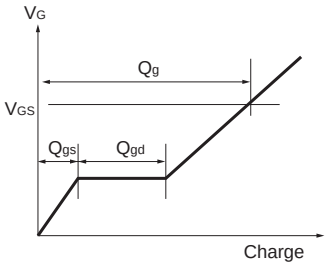


Fig.2-2 Gate Charge Waveform

●Notice

This product might cause chip aging and breakdown under the large electrified environment.
Please consider to design ESD protection circuit.

Appendix

Notes

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